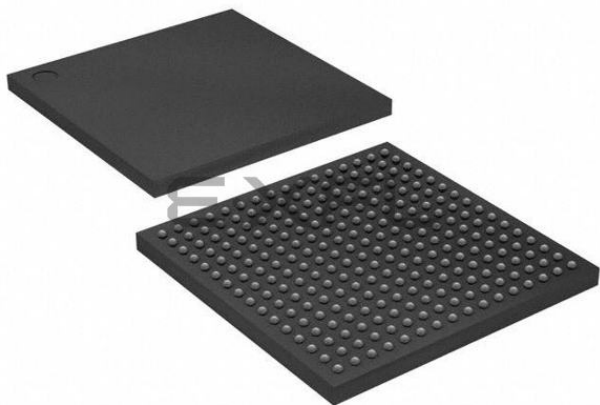




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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	64
Number of Logic Elements/Cells	-
Total RAM Bits	73728
Number of I/O	88
Number of Gates	40000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v40-5fgg256c

Table 5: Summary of Voltage Supply Requirements for All Input and Output Standards

I/O Standard	V _{CCO}		V _{REF}	Termination Type	
	Output	Input	Input	Output	Input
LVDS_33	3.3	N/R	N/R ⁽¹⁾	N/R	N/R
LVDSEXT_33			N/R	N/R	N/R
LVPECL_33			N/R	N/R	N/R
SSTL3_I			1.5	N/R	N/R
SSTL3_II			1.5	N/R	N/R
AGP			1.32	N/R	N/R
LVTTTL		3.3	N/R	N/R	N/R
LVC MOS33			N/R	N/R	N/R
LVDCI_33			N/R	Series	N/R
LVDCI_DV2_33			N/R	Series	N/R
PCI33_3			N/R	N/R	N/R
PCI66_3			N/R	N/R	N/R
PCIX			N/R	N/R	N/R
SSTL3_I_DCI			1.5	N/R	Split
SSTL3_II_DCI			1.5	Split	Split
LVDS_25	2.5	N/R	N/R	N/R	N/R
LVDSEXT_25			N/R	N/R	N/R
LDT_25			N/R	N/R	N/R
ULVDS_25			N/R	N/R	N/R
BLVDS_25			N/R	N/R	N/R
SSTL2_I			1.25	N/R	N/R
SSTL2_II			1.25	N/R	N/R
LVC MOS25		2.5	N/R	N/R	N/R
LVDCI_25			N/R	Series	N/R
LVDCI_DV2_25			N/R	Series	N/R
LVDS_25_DCI			N/R	N/R	Split
LVDSEXT_25_DC I			N/R	N/R	Split
SSTL2_I_DCI			1.25	N/R	Split
SSTL2_II_DCI			1.25	Split	Split

Table 5: Summary of Voltage Supply Requirements for All Input and Output Standards (Continued)

I/O Standard	V _{CCO}		V _{REF}	Termination Type	
	Output	Input	Input	Output	Input
HSTL_III_18	1.8	N/R	1.1	N/R	N/R
HSTL_IV_18			1.1	N/R	N/R
HSTL_I_18			0.9	N/R	N/R
HSTL_II_18			0.9	N/R	N/R
SSTL18_I			0.9	N/R	N/R
SSTL18_II			0.9	N/R	N/R
LVC MOS18		1.8	N/R	N/R	N/R
LVDCI_18			N/R	Series	N/R
LVDCI_DV2_18			N/R	Series	N/R
HSTL_III_DCI_18			1.1	N/R	Single
HSTL_IV_DCI_18			1.1	Single	Single
HSTL_I_DCI_18			0.9	N/R	Split
HSTL_II_DCI_18			0.9	Split	Split
SSTL18_I_DCI			0.9	N/R	Split
SSTL18_II_DCI			0.9	Split	Split
HSTL_III	1.5	N/R	0.9	N/R	N/R
HSTL_IV			0.9	N/R	N/R
HSTL_I			0.75	N/R	N/R
HSTL_II			0.75	N/R	N/R
LVC MOS15		1.5	N/R	N/R	N/R
LVDCI_15			N/R	Series	N/R
LVDCI_DV2_15			N/R	Series	N/R
GTLP_DCI			1	Single	Single
HSTL_III_DCI			0.9	N/R	Single
HSTL_IV_DCI			0.9	Single	Single
HSTL_I_DCI			0.75	N/R	Split
HSTL_II_DCI			0.75	Split	Split
GTLP	1.2	1.2	0.8	Single	Single
GTLP	N/R	N/R	1	N/R	N/R
GTL			0.8	N/R	N/R

Notes:

1. N/R = no requirement.

Configurable Logic Blocks (CLBs)

The Virtex-II configurable logic blocks (CLB) are organized in an array and are used to build combinatorial and synchronous logic designs. Each CLB element is tied to a switch matrix to access the general routing matrix, as shown in Figure 14. A CLB element comprises 4 similar slices, with fast local feedback within the CLB. The four slices are split in two columns of two slices with two independent carry logic chains and one common shift chain.

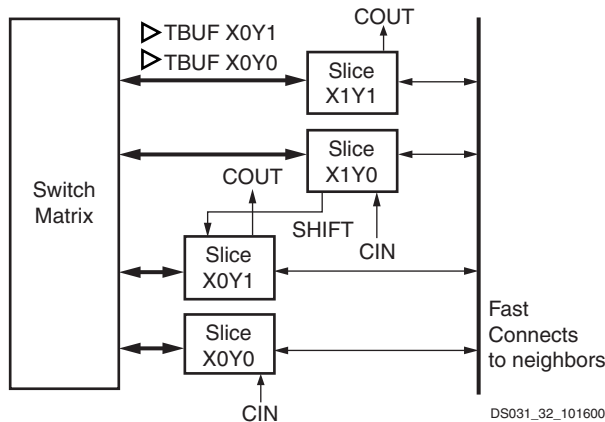


Figure 14: Virtex-II CLB Element

Slice Description

Each slice includes two 4-input function generators, carry logic, arithmetic logic gates, wide function multiplexers and two storage elements. As shown in Figure 15, each 4-input function generator is programmable as a 4-input LUT, 16 bits of distributed SelectRAM memory, or a 16-bit variable-tap shift register element.

The output from the function generator in each slice drives both the slice output and the D input of the storage element. Figure 16 shows a more detailed view of a single slice.

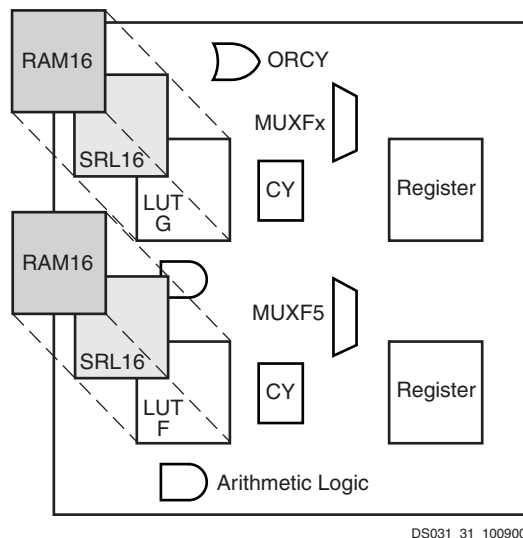


Figure 15: Virtex-II Slice Configuration

Configurations

Look-Up Table

Virtex-II function generators are implemented as 4-input look-up tables (LUTs). Four independent inputs are provided to each of the two function generators in a slice (F and G). These function generators are each capable of implementing any arbitrarily defined boolean function of four inputs. The propagation delay is therefore independent of the function implemented. Signals from the function generators can exit the slice (X or Y output), can input the XOR dedicated gate (see arithmetic logic), or input the carry-logic multiplexer (see fast look-ahead carry logic), or feed the D input of the storage element, or go to the MUXF5 (not shown in Figure 16).

In addition to the basic LUTs, the Virtex-II slice contains logic (MUXF5 and MUXFX multiplexers) that combines function generators to provide any function of five, six, seven, or eight inputs. The MUXFX are either MUXF6, MUXF7 or MUXF8 according to the slice considered in the CLB. Selected functions up to nine inputs (MUXF5 multiplexer) can be implemented in one slice. The MUXFX can also be a MUXF6, MUXF7, or MUXF8 multiplexers to map any functions of six, seven, or eight inputs and selected wide logic functions.

Register/Latch

The storage elements in a Virtex-II slice can be configured either as edge-triggered D-type flip-flops or as level-sensitive latches. The D input can be directly driven by the X or Y output via the DX or DY input, or by the slice inputs bypassing the function generators via the BX or BY input. The clock enable signal (CE) is active High by default. If left unconnected, the clock enable for that storage element defaults to the active state.

In addition to clock (CK) and clock enable (CE) signals, each slice has set and reset signals (SR and BY slice inputs). SR forces the storage element into the state specified by the attribute SRHIGH or SRLOW. SRHIGH forces a logic "1" when SR is asserted. SRLOW forces a logic "0". When SR is used, a second input (BY) forces the storage element into the opposite state. The reset condition is predominant over the set condition. (See Figure 17.)

The initial state after configuration or global initial state is defined by a separate INIT0 and INIT1 attribute. By default, setting the SRLOW attribute sets INIT0, and setting the SRHIGH attribute sets INIT1. For each slice, set and reset can be set to be synchronous or asynchronous. Virtex-II devices also have the ability to set INIT0 and INIT1 independent of SRHIGH and SRLOW.

The control signals clock (CLK), clock enable (CE) and set/reset (SR) are common to both storage elements in one slice. All of the control signals have independent polarity. Any inverter placed on a control input is automatically absorbed.

Date	Version	Revision
07/16/02	2.0	Updated compatible input standards listed in Table 6.
09/26/02	2.1	- Changed number of resources available to the XC2V40 device in Table 13. - Clarified Power On Reset information under Configuration Sequence.
12/06/02	2.1.1	Cosmetic edits.
05/07/03	2.1.2	- Added qualification note to Figure 13, page 11. - Corrected sentence in section Input/Output Individual Options, page 4, to read "The optional weak-keeper circuit is connected to each user I/O pad." - Corrected typographical errors in Table 3 for names of HSTL_[x]_DCI_18 standards.
06/19/03	2.2	- Removed Compatible Output Standards and Compatible Input Standards tables. - Added new Table 5, Summary of Voltage Supply Requirements for All Input and Output Standards. This table replaces deleted I/O standards tables. - Added section Rules for Combining I/O Standards in the Same Bank, page 6.
08/01/03	3.0	All Virtex-II devices and speed grades now Production. See Table 13, Module 3.
10/14/03	3.1	- Added section Local Clocking, page 29. - Table 1, page 1: - Added SSTL18_I and SSTL18_II. - Corrected names of 1.8V HSTL_I-IV standards to "HSTL_I-IV_18". - Corrected Input V_{REF} for HSTL_III-IV_18 from 1.08V to 1.1V. - Changed "N/A" to "N/R" (no requirement). - Table 2, page 2: - Changed "N/A" to "N/R" (no requirement). - Table 3, page 2: - Added SSTL18_I_DCI, SSTL18_II_DCI, LVDS_33_DCI, LVDSEXT_33_DCI, LVDS_25_DCI, and LVDSEXT_25_DCI. - Corrected Input V_{REF} for HSTL_III-IV_18 from 1.08V to 1.1V. - Sections Slave-Serial Mode and Master-Serial Mode, page 36: Changed "rising" to "falling" edge with respect to DOUT. - Added verbiage to section Bitstream Encryption, page 38: "For devices that support this feature, please contact your sales representative for specific ordering part number."
03/29/04	3.2	- Table 2, page 2, and Table 5, page 7: Removed LVDS_33_DCI and LVDSEXT_33_DCI from tables. - Table 26, page 37: Updated bitstream lengths. - Section BUFGMUX, page 29: Corrected the definition of the "presently selected clock" to be I0 or I1. Corrected signal names in Figure 44 and associated text from CLK0 and CLK1 to I0 and I1. - Recompiled for backward compatibility with Acrobat 4 and above.
06/24/04	3.3	- Table 1, page 1: Added example to Footnote (1) regarding V_{CCO} rules for GTL and GTLP. - Added reference to Pb-free package types in Figure 7, page 6.
03/01/05	3.4	- Reassigned heading hierarchies for better agreement with content. - Table 2: Corrected V_{OD} output voltages. - Table 26: Updated bitstream lengths.
11/05/07	3.5	- Updated copyright statement and legal disclaimer. - Boundary-Scan (JTAG, IEEE 1532) Mode, page 37: Updated IEEE 1149.1 compliance statement.

Table 17: IOB Output Switching Characteristics Standard Adjustments (Continued)

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-6	-5	-4	
LVC MOS, 2.5V, Fast, 16 mA	LVC MOS25_F16	T _{OLVCMOS25_F16}	-0.18	-0.19	-0.21	ns
LVC MOS, 2.5V, Fast, 24 mA	LVC MOS25_F24	T _{OLVCMOS25_F24}	-0.35	-0.36	-0.40	ns
LVC MOS, 1.8V, Slow, 2 mA	LVC MOS18_S2	T _{OLVCMOS18_S2}	15.62	16.10	17.71	ns
LVC MOS, 1.8V, Slow, 4 mA	LVC MOS18_S4	T _{OLVCMOS18_S4}	10.20	10.51	11.57	ns
LVC MOS, 1.8V, Slow, 6 mA	LVC MOS18_S6	T _{OLVCMOS18_S6}	7.52	7.75	8.53	ns
LVC MOS, 1.8V, Slow, 8 mA	LVC MOS18_S8	T _{OLVCMOS18_S8}	6.87	7.08	7.78	ns
LVC MOS, 1.8V, Slow, 12 mA	LVC MOS18_S12	T _{OLVCMOS18_S12}	5.54	5.71	6.28	ns
LVC MOS, 1.8V, Slow, 16 mA	LVC MOS18_S16	T _{OLVCMOS18_S16}	5.31	5.47	6.02	ns
LVC MOS, 1.8V, Fast, 2 mA	LVC MOS18_F2	T _{OLVCMOS18_F2}	5.55	5.72	6.30	ns
LVC MOS, 1.8V, Fast, 4 mA	LVC MOS18_F4	T _{OLVCMOS18_F4}	1.89	1.95	2.15	ns
LVC MOS, 1.8V, Fast, 6 mA	LVC MOS18_F6	T _{OLVCMOS18_F6}	0.83	0.85	0.94	ns
LVC MOS, 1.8V, Fast, 8 mA	LVC MOS18_F8	T _{OLVCMOS18_F8}	0.70	0.72	0.80	ns
LVC MOS, 1.8V, Fast, 12 mA	LVC MOS18_F12	T _{OLVCMOS18_F12}	0.26	0.27	0.30	ns
LVC MOS, 1.8V, Fast, 16 mA	LVC MOS18_F16	T _{OLVCMOS18_F16}	0.23	0.23	0.26	ns
LVC MOS, 1.5V, Slow, 2 mA	LVC MOS15_S2	T _{OLVCMOS15_S2}	18.96	19.55	21.50	ns
LVC MOS, 1.5V, Slow, 4 mA	LVC MOS15_S4	T _{OLVCMOS15_S4}	12.77	13.17	14.48	ns
LVC MOS, 1.5V, Slow, 6 mA	LVC MOS15_S6	T _{OLVCMOS15_S6}	12.05	12.42	13.66	ns
LVC MOS, 1.5V, Slow, 8 mA	LVC MOS15_S8	T _{OLVCMOS15_S8}	9.75	10.06	11.06	ns
LVC MOS, 1.5V, Slow, 12 mA	LVC MOS15_S12	T _{OLVCMOS15_S12}	9.04	9.32	10.25	ns
LVC MOS, 1.5V, Slow, 16 mA	LVC MOS15_S16	T _{OLVCMOS15_S16}	8.21	8.46	9.31	ns
LVC MOS, 1.5V, Fast, 2 mA	LVC MOS15_F2	T _{OLVCMOS15_F2}	5.09	5.25	5.78	ns
LVC MOS, 1.5V, Fast, 4 mA	LVC MOS15_F4	T _{OLVCMOS15_F4}	2.01	2.07	2.27	ns
LVC MOS, 1.5V, Fast, 6 mA	LVC MOS15_F6	T _{OLVCMOS15_F6}	1.46	1.51	1.66	ns
LVC MOS, 1.5V, Fast, 8 mA	LVC MOS15_F8	T _{OLVCMOS15_F8}	0.93	0.96	1.05	ns
LVC MOS, 1.5V, Fast, 12 mA	LVC MOS15_F12	T _{OLVCMOS15_F12}	0.74	0.77	0.84	ns
LVC MOS, 1.5V, Fast, 16 mA	LVC MOS15_F16	T _{OLVCMOS15_F16}	0.67	0.69	0.75	ns
LVDS (Low-Voltage Differential Signaling), 2.5V	LVDS_25	T _{OLVDS_25}	-0.31	-0.32	-0.36	ns
LVDS, 3.3V	LVDS_33	T _{OLVDS_33}	-0.25	-0.26	-0.29	ns
LVDSEXT (LVDS Extended Mode), 2.5V	LVDSEXT_25	T _{OLVDSEXT_25}	-0.18	-0.19	-0.21	ns
LVDSEXT, 3.3V	LVDSEXT_33	T _{OLVDSEXT_33}	-0.17	-0.18	-0.19	ns
ULVDS (Ultra LVDS), 2.5V	ULVDS_25	T _{OLVDS_25}	-0.20	-0.21	-0.23	ns
BLVDS (Bus LVDS), 2.5V	BLVDS_25	T _{OBLVDS_25}	0.67	0.69	0.76	ns
LDT (HyperTransport), 2.5V	LDT_25	T _{OLDT_25}	-0.20	-0.21	-0.23	ns
LVPECL (Low-Voltage Positive Electron-Coupled Logic), 3.3V	LVPECL_33	T _{OLVPECL_33}	0.29	0.30	0.33	ns
PCI (Peripheral Component Interface), 33 MHz, 3.3V	PCI33_3	T _{OPCI33_3}	1.15	1.19	1.31	ns
PCI, 66 MHz, 3.3V	PCI66_3	T _{OPCI66_3}	-0.01	-0.01	-0.01	ns
PCI-X, 133 MHz, 3.3V	PCIX	T _{OPCIX}	-0.01	-0.01	-0.01	ns
GTL (Gunning Transceiver Logic)	GTL	T _{OGTL}	-0.31	-0.32	-0.36	ns
GTL Plus	GTL P	T _{OGTLP}	-0.17	-0.18	-0.20	ns
HSTL (High-Speed Transceiver Logic), Class I	HSTL_I	T _{OHSTL_I}	0.26	0.27	0.29	ns
HSTL, Class II	HSTL_II	T _{OHSTL_II}	-0.15	-0.16	-0.17	ns
HSTL, Class III	HSTL_III	T _{OHSTL_III}	-0.17	-0.17	-0.19	ns
HSTL, Class IV	HSTL_IV	T _{OHSTL_IV}	-0.40	-0.41	-0.45	ns
HSTL, Class I, 1.8V	HSTL_I_18	T _{OHSTL_I_18}	0.03	0.03	0.04	ns

Table 17: IOB Output Switching Characteristics Standard Adjustments (Continued)

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-6	-5	-4	
HSTL, Class II, 1.8V	HSTL_II_18	T _{OHSTL_II_18}	-0.17	-0.18	-0.20	ns
HSTL, Class III, 1.8V	HSTL_III_18	T _{OHSTL_III_18}	-0.16	-0.16	-0.18	ns
HSTL, Class IV, 1.8V	HSTL_IV_18	T _{OHSTL_IV_18}	-0.39	-0.40	-0.44	ns
SSTL (Stub Series Terminated Logic), Class I, 1.8V	SSTL18_I	T _{OSSTL18_I}	0.20	0.20	0.22	ns
SSTL, Class II, 1.8V	SSTL18_II	T _{OSSTL18_II}	-0.05	-0.05	-0.06	ns
SSTL, Class I, 2.5V	SSTL2_I	T _{OSSTL2_I}	0.21	0.22	0.24	ns
SSTL, Class II, 2.5V	SSTL2_II	T _{OSSTL2_II}	-0.15	-0.16	-0.18	ns
SSTL, Class I, 3.3V	SSTL3_I	T _{OSSTL3_I}	0.29	0.30	0.33	ns
SSTL, Class II, 3.3V	SSTL3_II	T _{OSSTL3_II}	-0.05	-0.05	-0.05	ns
AGP-2X/AGP (Accelerated Graphics Port)	AGP	T _{OAGP}	-0.27	-0.28	-0.31	ns
LVDCI (Low-Voltage Digitally Controlled Impedance), 3.3V	LVDCI_33	T _{OLVDCI_33}	0.74	0.77	0.84	ns
LVDCI, 2.5V	LVDCI_25	T _{OLVDCI_25}	0.78	0.80	0.88	ns
LVDCI, 1.8V	LVDCI_18	T _{OLVDCI_18}	0.84	0.87	0.95	ns
LVDCI, 1.5V	LVDCI_15	T _{OLVDCI_15}	1.82	1.88	2.06	ns
LVDCI, 3.3V, Half-Impedance	LVDCI_DV2_33	T _{OLVDCI_DV2_33}	0.12	0.12	0.13	ns
LVDCI, 2.5V, Half-Impedance	LVDCI_DV2_25	T _{OLVDCI_DV2_25}	0.03	0.03	0.03	ns
LVDCI, 1.8V, Half-Impedance	LVDCI_DV2_18	T _{OLVDCI_DV2_18}	0.42	0.43	0.48	ns
LVDCI, 1.5V, Half-Impedance	LVDCI_DV2_15	T _{OLVDCI_DV2_15}	1.20	1.23	1.36	ns
HSLVDCI (High-Speed Low-Voltage DCI), 1.5V	HSLVDCI_15	T _{OHSLVDCI_15}	1.82	1.88	2.06	ns
HSLVDCI, 1.8V	HSLVDCI_18	T _{OHSLVDCI_18}	1.05	1.08	1.24	ns
HSLVDCI, 2.5V	HSLVDCI_25	T _{OHSLVDCI_25}	0.78	0.80	0.88	ns
HSLVDCI, 3.3V	HSLVDCI_33	T _{OHSLVDCI_33}	0.74	0.77	0.84	ns
GTL (Gunning Transceiver Logic) with DCI	GTL_DCI	T _{OGTL_DCI}	-0.31	-0.32	-0.35	ns
GTL Plus with DCI	GTL_P_DCI	T _{OGTL_P_DCI}	-0.15	-0.16	-0.17	ns
HSTL (High-Speed Transceiver Logic), Class I, with DCI	HSTL_I_DCI	T _{OHSTL_I_DCI}	0.23	0.23	0.26	ns
HSTL, Class II, with DCI	HSTL_II_DCI	T _{OHSTL_II_DCI}	0.06	0.06	0.07	ns
HSTL, Class III, with DCI	HSTL_III_DCI	T _{OHSTL_III_DCI}	-0.17	-0.18	-0.20	ns
HSTL, Class IV, with DCI	HSTL_IV_DCI	T _{OHSTL_IV_DCI}	-0.46	-0.47	-0.52	ns
HSTL, Class I, 1.8V, with DCI	HSTL_I_DCI_18	T _{OHSTL_I_DCI_18}	0.05	0.05	0.06	ns
HSTL, Class II, 1.8V, with DCI	HSTL_II_DCI_18	T _{OHSTL_II_DCI_18}	-0.03	-0.03	-0.03	ns
HSTL, Class III, 1.8V, with DCI	HSTL_III_DCI_18	T _{OHSTL_III_DCI_18}	-0.14	-0.14	-0.16	ns
HSTL, Class IV, 1.8V, with DCI	HSTL_IV_DCI_18	T _{OHSTL_IV_DCI_18}	-0.41	-0.42	-0.47	ns
SSTL (Stub Series Terminated Logic), Class I, 1.8V, with DCI	SSTL18_I_DCI	T _{OSSTL18_I_DCI}	0.36	0.37	0.40	ns
SSTL, Class II, 1.8V, with DCI	SSTL18_II_DCI	T _{OSSTL18_II_DCI}	0.06	0.06	0.07	ns
SSTL, Class I, 2.5V, with DCI	SSTL2_I_DCI	T _{OSSTL2_I_DCI}	0.12	0.13	0.14	ns
SSTL, Class II, 2.5V, with DCI	SSTL2_II_DCI	T _{OSSTL2_II_DCI}	-0.10	-0.10	-0.11	ns
SSTL, Class I, 3.3V, with DCI	SSTL3_I_DCI	T _{OSSTL3_I_DCI}	0.15	0.16	0.17	ns
SSTL, Class II, 3.3V, with DCI	SSTL3_II_DCI	T _{OSSTL3_II_DCI}	0.08	0.08	0.09	ns

Input Clock Tolerances

Table 39: Input Clock Tolerances

Description	Symbol	Constraints F _{CLKIN}	Speed Grade						Units
			-6		-5		-4		
			Min	Max	Min	Max	Min	Max	
Input Clock Low/High Pulse Width									
PSCLK	PSCLK_PULSE	< 1MHz	25.00		25.00		25.00		ns
PSCLK and CLKIN ⁽³⁾	PSCLK_PULSE and CLKIN_PULSE	1 – 10 MHz	25.00		25.00		25.00		ns
		10 – 25 MHz	10.00		10.00		10.00		ns
		25 – 50 MHz	5.00		5.00		5.00		ns
		50 – 100 MHz	3.00		3.00		3.00		ns
		100 – 150 MHz	2.40		2.40		2.40		ns
		150 – 200 MHz	2.00		2.00		2.00		ns
		200 – 250 MHz	1.80		1.80		1.80		ns
		250 – 300 MHz	1.50		1.50		1.50		ns
		300 – 350 MHz	1.30		1.30		1.30		ns
		350 – 400 MHz	1.15		1.15		1.15		ns
> 400 MHz	1.05		1.05		1.05		ns		
Input Clock Cycle-Cycle Jitter (Low Frequency Mode)									
CLKIN (using DLL outputs) ⁽¹⁾	CLKIN_CYC_JITT_DLL_LF			±300		±300		±300	ps
CLKIN (using CLKFX outputs) ⁽²⁾	CLKIN_CYC_JITT_FX_LF			±300		±300		±300	ps
Input Clock Cycle-Cycle Jitter (High Frequency Mode)									
CLKIN (using DLL outputs) ⁽¹⁾	CLKIN_CYC_JITT_DLL_HF			±150		±150		±150	ps
CLKIN (using CLKFX outputs) ⁽²⁾	CLKIN_CYC_JITT_FX_HF			±150		±150		±150	ps
Input Clock Period Jitter (Low Frequency Mode)									
CLKIN (using DLL outputs) ⁽¹⁾	CLKIN_PER_JITT_DLL_LF			±1		±1		±1	ns
CLKIN (using CLKFX outputs) ⁽²⁾	CLKIN_PER_JITT_FX_LF			±1		±1		±1	ns
Input Clock Period Jitter (High Frequency Mode)									
CLKIN (using DLL outputs) ⁽¹⁾	CLKIN_PER_JITT_DLL_HF			±1		±1		±1	ns
CLKIN (using CLKFX outputs) ⁽²⁾	CLKIN_PER_JITT_FX_HF			±1		±1		±1	ns
Feedback Clock Path Delay Variation									
CLKFB off-chip feedback	CLKFB_DELAY_VAR_EXT			±1		±1		±1	ns

Notes:

- “DLL outputs” is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
- If both DLL and CLKFX outputs are used, follow the more restrictive specification.
- If DCM phase shift feature is used and CLKIN frequency > 200 Mhz, CLKIN duty cycle must be within ±5% (45/55 to 55/45).

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
1	IO_L19N_1	E20		
1	IO_L19P_1	F20		
1	IO_L06N_1	B21		
1	IO_L06P_1	B22		
1	IO_L05N_1	A22		
1	IO_L05P_1	A23		
1	IO_L04N_1	C21		
1	IO_L04P_1/VREF_1	D21		
1	IO_L03N_1/VRP_1	C20		
1	IO_L03P_1/VRN_1	D20		
1	IO_L02N_1	A24		
1	IO_L02P_1	A25		
1	IO_L01N_1	B23		
1	IO_L01P_1	B24		
2	IO_L01N_2	B26		
2	IO_L01P_2	C26		
2	IO_L02N_2/VRP_2	G20		
2	IO_L02P_2/VRN_2	H20		
2	IO_L03N_2	C25		
2	IO_L03P_2/VREF_2	D25		
2	IO_L04N_2	E23		
2	IO_L04P_2	E24		
2	IO_L06N_2	G21		
2	IO_L06P_2	G22		
2	IO_L19N_2	D26		
2	IO_L19P_2	E26		
2	IO_L21N_2	F23		
2	IO_L21P_2/VREF_2	F24		
2	IO_L22N_2	E25		
2	IO_L22P_2	F25		
2	IO_L24N_2	H22		
2	IO_L24P_2	H21		
2	IO_L25N_2	G23	NC	NC
2	IO_L25P_2	G24	NC	NC
2	IO_L43N_2	F26		
2	IO_L43P_2	G26		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
2	IO_L45N_2	H23		
2	IO_L45P_2/VREF_2	H24		
2	IO_L46N_2	J21		
2	IO_L46P_2	J20		
2	IO_L48N_2	H25		
2	IO_L48P_2	H26		
2	IO_L49N_2	J22		
2	IO_L49P_2	J23		
2	IO_L51N_2	K21		
2	IO_L51P_2/VREF_2	K22		
2	IO_L52N_2	K20		
2	IO_L52P_2	L20		
2	IO_L54N_2	J24		
2	IO_L54P_2	J25		
2	IO_L67N_2	K23		
2	IO_L67P_2	K24		
2	IO_L69N_2	J26		
2	IO_L69P_2/VREF_2	K26		
2	IO_L70N_2	L22		
2	IO_L70P_2	L21		
2	IO_L72N_2	L25		
2	IO_L72P_2	L26		
2	IO_L73N_2	L19	NC	
2	IO_L73P_2	M19	NC	
2	IO_L75N_2	L23	NC	
2	IO_L75P_2/VREF_2	L24	NC	
2	IO_L76N_2	M22	NC	
2	IO_L76P_2	M21	NC	
2	IO_L78N_2	M23	NC	
2	IO_L78P_2	M24	NC	
2	IO_L91N_2	M25		
2	IO_L91P_2	M26		
2	IO_L93N_2	M20		
2	IO_L93P_2/VREF_2	N20		
2	IO_L94N_2	N22		
2	IO_L94P_2	N21		
2	IO_L96N_2	N24		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
2	IO_L96P_2	N23		
3	IO_L96N_3	N26		
3	IO_L96P_3	P26		
3	IO_L94N_3	P23		
3	IO_L94P_3	P22		
3	IO_L93N_3/VREF_3	P19		
3	IO_L93P_3	N19		
3	IO_L91N_3	P21		
3	IO_L91P_3	P20		
3	IO_L78N_3	R26	NC	
3	IO_L78P_3	R25	NC	
3	IO_L76N_3	R20	NC	
3	IO_L76P_3	R19	NC	
3	IO_L75N_3/VREF_3	R24	NC	
3	IO_L75P_3	R23	NC	
3	IO_L73N_3	R22	NC	
3	IO_L73P_3	R21	NC	
3	IO_L72N_3	T26		
3	IO_L72P_3	T25		
3	IO_L70N_3	T20		
3	IO_L70P_3	T19		
3	IO_L69N_3/VREF_3	T24		
3	IO_L69P_3	T23		
3	IO_L67N_3	T22		
3	IO_L67P_3	T21		
3	IO_L54N_3	U26		
3	IO_L54P_3	V26		
3	IO_L52N_3	U24		
3	IO_L52P_3	U23		
3	IO_L51N_3/VREF_3	U22		
3	IO_L51P_3	U21		
3	IO_L49N_3	V25		
3	IO_L49P_3	V24		
3	IO_L48N_3	V23		
3	IO_L48P_3	V22		
3	IO_L46N_3	W26		

BG575/BGG575 Standard BGA Package

As shown in Table 9, XC2V1000, XC2V1500, and XC2V2000 Virtex-II devices are available in the BG575/BGG575 BGA package. Pins in the XC2V1000, XC2V1500, and XC2V2000 devices are the same, except for the pin differences in the XC2V1000 and XC2V1500 devices shown in the No Connect columns. Following this table are the **BG575/BGG575 Standard BGA Package Specifications (1.27mm pitch)**.

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
0	IO_L01N_0	A3		
0	IO_L01P_0	A4		
0	IO_L02N_0	D5		
0	IO_L02P_0	C5		
0	IO_L03N_0/VRP_0	E6		
0	IO_L03P_0/VRN_0	D6		
0	IO_L04N_0/VREF_0	F7		
0	IO_L04P_0	E7		
0	IO_L05N_0	G8		
0	IO_L05P_0	H9		
0	IO_L06N_0	A5		
0	IO_L06P_0	A6		
0	IO_L19N_0	B5		
0	IO_L19P_0	B6		
0	IO_L21N_0	D7		
0	IO_L21P_0/VREF_0	C7		
0	IO_L22N_0	F8		
0	IO_L22P_0	E8		
0	IO_L24N_0	G9		
0	IO_L24P_0	F9		
0	IO_L49N_0	G10		
0	IO_L49P_0	H10		
0	IO_L51N_0	B7		
0	IO_L51P_0/VREF_0	B8		
0	IO_L52N_0	D8		
0	IO_L52P_0	C8		
0	IO_L54N_0	E9		
0	IO_L54P_0	D9		
0	IO_L67N_0	A8	NC	
0	IO_L67P_0	A9	NC	
0	IO_L69N_0	C9	NC	

Table 9: BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
NA	VCCINT	R10		
NA	VCCINT	P15		
NA	VCCINT	P10		
NA	VCCINT	N15		
NA	VCCINT	N10		
NA	VCCINT	M15		
NA	VCCINT	M10		
NA	VCCINT	L15		
NA	VCCINT	L10		
NA	VCCINT	K15		
NA	VCCINT	K14		
NA	VCCINT	K13		
NA	VCCINT	K12		
NA	VCCINT	K11		
NA	VCCINT	K10		
NA	VCCINT	J16		
NA	VCCINT	J9		
NA	VCCINT	H17		
NA	VCCINT	H8		
NA	GND	AD24		
NA	GND	AD23		
NA	GND	AD18		
NA	GND	AD7		
NA	GND	AD2		
NA	GND	AD1		
NA	GND	AC24		
NA	GND	AC23		
NA	GND	AC2		
NA	GND	AC1		
NA	GND	AB22		
NA	GND	AB3		
NA	GND	AA21		
NA	GND	AA15		
NA	GND	AA10		
NA	GND	AA4		
NA	GND	Y20		

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
6	VCCO_6	AF29		
6	VCCO_6	AA22		
6	VCCO_6	Y22		
6	VCCO_6	Y21		
6	VCCO_6	W22		
6	VCCO_6	W21		
6	VCCO_6	V28		
6	VCCO_6	V22		
6	VCCO_6	V21		
6	VCCO_6	U21		
6	VCCO_6	T21		
7	VCCO_7	R21		
7	VCCO_7	P21		
7	VCCO_7	N28		
7	VCCO_7	N22		
7	VCCO_7	N21		
7	VCCO_7	M22		
7	VCCO_7	M21		
7	VCCO_7	L22		
7	VCCO_7	L21		
7	VCCO_7	K22		
7	VCCO_7	E29		
NA	CCLK	AF6		
NA	PROG_B	B28		
NA	DONE	AG5		
NA	M0	AF25		
NA	M1	AG26		
NA	M2	AH27		
NA	HSWAP_EN	C27		
NA	TCK	D5		
NA	TDI	A29		
NA	TDO	B3		
NA	TMS	C4		
NA	PWRDWN_B	AH4		
NA	DXN	D26		
NA	DXP	E25		

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
NA	GND	M5		
NA	GND	K28		
NA	GND	K3		
NA	GND	H30		
NA	GND	H1		
NA	GND	G17		
NA	GND	G14		
NA	GND	F25		
NA	GND	F6		
NA	GND	E26		
NA	GND	E19		
NA	GND	E12		
NA	GND	E5		
NA	GND	D27		
NA	GND	D4		
NA	GND	C28		
NA	GND	C21		
NA	GND	C10		
NA	GND	C3		
NA	GND	B29		
NA	GND	B2		
NA	GND	A23		
NA	GND	A8		

Notes:

1. See Table 4 for an explanation of the signals available on this pin.

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
6	IO_L95P_6	W30	
6	IO_L95N_6	V30	
6	IO_L96P_6	V32	
6	IO_L96N_6	W32	
7	IO_L96P_7	U31	
7	IO_L96N_7	V31	
7	IO_L95P_7	T28	
7	IO_L95N_7	U28	
7	IO_L94P_7	U33	
7	IO_L94N_7	U34	
7	IO_L93P_7/VREF_7	U29	
7	IO_L93N_7	T29	
7	IO_L92P_7	U27	
7	IO_L92N_7	U26	
7	IO_L91P_7	T30	
7	IO_L91N_7	U30	
7	IO_L84P_7	R32	NC
7	IO_L84N_7	T32	NC
7	IO_L83P_7	U25	NC
7	IO_L83N_7	T25	NC
7	IO_L82P_7	R34	NC
7	IO_L82N_7	T33	NC
7	IO_L81P_7/VREF_7	N34	NC
7	IO_L81N_7	P34	NC
7	IO_L80P_7	U24	NC
7	IO_L80N_7	T24	NC
7	IO_L79P_7	R31	NC
7	IO_L79N_7	T31	NC
7	IO_L78P_7	N32	
7	IO_L78N_7	P32	
7	IO_L77P_7	T27	
7	IO_L77N_7	R27	
7	IO_L76P_7	N33	
7	IO_L76N_7	P33	
7	IO_L75P_7/VREF_7	R29	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
NA	GND	P20	
NA	GND	P19	
NA	GND	P18	
NA	GND	P17	
NA	GND	P16	
NA	GND	P15	
NA	GND	P14	
NA	GND	P7	
NA	GND	M30	
NA	GND	M5	
NA	GND	K32	
NA	GND	K3	
NA	GND	J19	
NA	GND	J16	
NA	GND	H34	
NA	GND	H27	
NA	GND	H8	
NA	GND	H1	
NA	GND	G28	
NA	GND	G21	
NA	GND	G14	
NA	GND	G7	
NA	GND	F29	
NA	GND	F6	
NA	GND	E30	
NA	GND	E23	
NA	GND	E12	
NA	GND	E5	
NA	GND	D31	
NA	GND	D4	
NA	GND	C34	
NA	GND	C32	
NA	GND	C25	
NA	GND	C10	
NA	GND	C3	
NA	GND	C1	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
0	IO_L76P_0	C24		
0	IO_L77N_0	K22		
0	IO_L77P_0	K21		
0	IO_L78N_0	E22		
0	IO_L78P_0	E23		
0	IO_L79N_0	B23		
0	IO_L79P_0	B24		
0	IO_L80N_0	J22		
0	IO_L80P_0	J21		
0	IO_L81N_0	G21		
0	IO_L81P_0/VREF_0	G22		
0	IO_L82N_0	A23		
0	IO_L82P_0	A24		
0	IO_L83N_0	H22		
0	IO_L83P_0	H21		
0	IO_L84N_0	F21		
0	IO_L84P_0	F22		
0	IO_L91N_0/VREF_0	B21		
0	IO_L91P_0	B22		
0	IO_L92N_0	L20		
0	IO_L92P_0	M20		
0	IO_L93N_0	E21		
0	IO_L93P_0	D22		
0	IO_L94N_0/VREF_0	A21		
0	IO_L94P_0	A22		
0	IO_L95N_0/GCLK7P	H20		
0	IO_L95P_0/GCLK6S	J20		
0	IO_L96N_0/GCLK5P	C21		
0	IO_L96P_0/GCLK4S	D21		
1	IO_L96N_1/GCLK3P	F19		
1	IO_L96P_1/GCLK2S	F20		
1	IO_L95N_1/GCLK1P	H19		
1	IO_L95P_1/GCLK0S	H18		
1	IO_L94N_1	C19		
1	IO_L94P_1/VREF_1	C20		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
6	IO_L71N_6	AE39		
6	IO_L72P_6	AD36		
6	IO_L72N_6	AE36		
6	IO_L73P_6	AB29		
6	IO_L73N_6	AA29		
6	IO_L74P_6	AE38		
6	IO_L74N_6	AD38		
6	IO_L75P_6	AC33		
6	IO_L75N_6/VREF_6	AD33		
6	IO_L76P_6	AB30		
6	IO_L76N_6	AA30		
6	IO_L77P_6	AD37		
6	IO_L77N_6	AC37		
6	IO_L78P_6	AB34		
6	IO_L78N_6	AC34		
6	IO_L79P_6	AB31		
6	IO_L79N_6	AA31		
6	IO_L80P_6	AD39		
6	IO_L80N_6	AC39		
6	IO_L81P_6	AB35		
6	IO_L81N_6/VREF_6	AC35		
6	IO_L82P_6	AB32		
6	IO_L82N_6	AA32		
6	IO_L83P_6	AC38		
6	IO_L83N_6	AB38		
6	IO_L84P_6	AA33		
6	IO_L84N_6	AB33		
6	IO_L91P_6	Y28		
6	IO_L91N_6	Y29		
6	IO_L92P_6	AB39		
6	IO_L92N_6	AA39		
6	IO_L93P_6	AA36		
6	IO_L93N_6/VREF_6	AB36		
6	IO_L94P_6	Y31		
6	IO_L94N_6	Y32		
6	IO_L95P_6	AA37		

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
5	IO_L73P_5	AJ20	
5	IO_L72N_5	AG18	
5	IO_L72P_5	AG19	
5	IO_L71N_5	AF18	
5	IO_L71P_5	AF19	
5	IO_L70N_5	AK20	
5	IO_L70P_5	AK21	
5	IO_L69N_5/VREF_5	AH20	
5	IO_L69P_5	AH21	
5	IO_L68N_5	AD19	
5	IO_L68P_5	AD20	
5	IO_L67N_5	AL21	
5	IO_L67P_5	AL22	
5	IO_L54N_5	AG20	
5	IO_L54P_5	AG21	
5	IO_L53N_5	AB19	
5	IO_L53P_5	AB20	
5	IO_L52N_5	AJ21	
5	IO_L52P_5	AJ22	
5	IO_L51N_5/VREF_5	AF20	
5	IO_L51P_5	AF21	
5	IO_L50N_5	AE20	
5	IO_L50P_5	AE21	
5	IO_L49N_5	AK22	
5	IO_L49P_5	AK23	
5	IO_L30N_5	AJ23	NC
5	IO_L30P_5	AJ24	NC
5	IO_L29N_5	AC20	NC
5	IO_L29P_5	AC21	NC
5	IO_L28N_5	AL23	NC
5	IO_L28P_5	AL24	NC
5	IO_L27N_5/VREF_5	AL25	NC
5	IO_L27P_5	AL26	NC
5	IO_L26N_5	AD21	NC
5	IO_L26P_5	AD22	NC
5	IO_L25N_5	AH23	NC
5	IO_L25P_5	AH24	NC
5	IO_L24N_5	AG22	

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
6	IO_L20P_6	AD25	
6	IO_L20N_6	AC24	
6	IO_L21P_6	AG30	
6	IO_L21N_6/VREF_6	AF30	
6	IO_L22P_6	AD26	
6	IO_L22N_6	AC26	
6	IO_L23P_6	AF29	
6	IO_L23N_6	AD29	
6	IO_L24P_6	AE28	
6	IO_L24N_6	AD28	
6	IO_L25P_6	AB24	NC
6	IO_L25N_6	AA24	NC
6	IO_L27P_6	AC25	NC
6	IO_L27N_6/VREF_6	AB25	NC
6	IO_L43P_6	AF31	
6	IO_L43N_6	AE31	
6	IO_L44P_6	AA23	
6	IO_L44N_6	Y23	
6	IO_L45P_6	AE30	
6	IO_L45N_6/VREF_6	AC30	
6	IO_L46P_6	AC28	
6	IO_L46N_6	AA28	
6	IO_L47P_6	AD27	
6	IO_L47N_6	AC27	
6	IO_L48P_6	AA25	
6	IO_L48N_6	Y25	
6	IO_L49P_6	AC29	
6	IO_L49N_6	AB29	
6	IO_L50P_6	AB27	
6	IO_L50N_6	AA27	
6	IO_L51P_6	AA26	
6	IO_L51N_6/VREF_6	Y26	
6	IO_L52P_6	AD31	
6	IO_L52N_6	AC31	
6	IO_L53P_6	W22	
6	IO_L53N_6	V22	
6	IO_L54P_6	Y27	
6	IO_L54N_6	W27	

Revision History

This section records the change history for this module of the data sheet.

Date	Version	Revision
11/07/00	1.0	Early access draft.
11/22/00	1.1	Initial Xilinx release. Made the following corrections: CS144 package - Table 5, page 5 : - Added missing pin D10 in Bank 1. - Changed dedicated pins A2 and B2 to RSVD (from DXN and DXP). FG256 package - Table 6, page 10 : - Changed dedicated pins A3 and A4 to RSVD (from DXN and DXP). FG896 package - Table 11, page 94 : - Corrected pin AG1 in Bank 4 to be AG12. FF1152 package - Table 12, page 120 : - Corrected pin Y3 in Bank 6 to be Y32.
12/19/00	1.2	Reverse designations were fixed for pins in every package.
01/25/01	1.3	Data sheet divided into four modules (per current style standard). DXN and DXP pin information added for CS144 package (Table 5) and FG256 package (Table 6).
02/07/01	1.4	DXN and DXP pin information was changed back to RSVD for the CS144 package (Table 5) and the FG256 package (Table 6).
04/02/01	1.5	- ALT_VRN and ALT_VRP pin information was added for each package. Table 8, page 34 – added No Connect designations for the XC2V1500 device in the FG676 package. - Reverted to traditional double-column format.
11/07/01	1.6	Updated list of devices supported in the FF1152, FF1517, and BF957 packages.
09/26/02	1.7	- Updated Table 3 to reflect devices supported in the BG728 and BF957 packages. - Added mention of LVPECL to pin definition in Table 4.
10/07/02	1.8	Corrected Table 10 heading to reflect supported devices in the BG728 package.
12/06/02	1.8.1	Enhanced the description of the PWRDWN_B pin in Table 4.
05/07/03	1.8.2	Added clarification to Table 4 and all device pinout tables regarding the dual-use nature of pins D0/DIN and BUSY/DOUT during configuration.
06/19/03	1.8.3	- The final GND pin in each of five pinout tables was inadvertently deleted in v1.8.2. This revision restores the deleted GND pins as follows: - Pin C5, Table 5, page 5 (CS144) - Pin A1, Table 6, page 10 (FG256) - Pin A2, Table 10, page 72 (BG728) - Pin A2, Table 12, page 120 (FF1152) - Pin AL30, Table 14, page 198 (BF957)
08/01/03	2.0	All Virtex-II devices and speed grades now Production. See Table 13, Module 3.
03/29/04	2.0.1	Recompiled for backward compatibility with Acrobat 4 and above.
06/24/04	3.3	Added references to, and new package drawings for, Pb-free wire-bond packages CSG, FGG, and BGG. (Revision number advanced to level of complete data sheet.)
03/01/05	3.4	Table 4 : Changed Direction for User I/O pins (IO_LXXY_#) from “Input/Output” to “Input/Output/Bidirectional”. Added requirement to V _{BATT} to connect pin to V _{CCAUX} or GND if battery is not used.
11/05/07	3.5	Updated copyright notice and legal disclaimer.